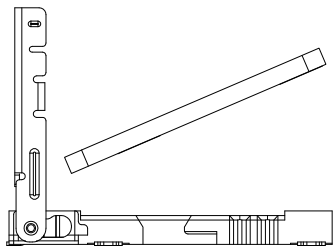


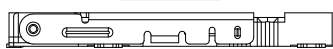
RECOMMENDED PCB LAYOUT  
GENERAL TOLERANCE ±0.05

NOTES:

- ELECTRICAL CHARACTERISTICS
  - 1-1. CONTACT RESISTANCE: 60 Milliohms Max
  - 1-2. INSULATION RESISTANCE: 1,000 Megohms Min.
  - 1-3. VOLTAGE RATING: 50V.
  - 1-4. CURRENT RATING: 1.0A.
- MECHANICAL CHARACTERISTICS
  - 2-1. OPERATION TEMPERATURE RANGE: -20°C~+85°C
  - 2-2. DURABILITY: 5000 CYCLES
- MATERIAL:
  - 3-1. HOUSING: THERMOPLASTIC,UL 94-V0
  - 3-2. TERMINAL: PHOSPHOR BRONZE,T=0.15
  - 3-3. SHELL: STAINLESS STEEL,T=0.20
- FINISHED:
  - 4-1. TERMINAL: Ni PLATED UNDER, 1U" Au MIN PLATED ON CONTACT AREA,AU PLATED ON SOLDER TAIL



STEP 1 INSERT Micro-SIM CARD

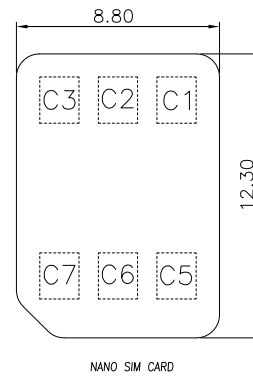


STEP 2 PUSH THE SHELL



STEP 3 FINISH

SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



NANO SIM CARD

设计	DESIGN	Nicolas		
校阅	CHECK	Nicolas		
承认	APPRO.			

**LXW** 连兴旺电子(深圳)有限公司  
LXWCONN ELECTRONICS (SHENZHEN) CO., LTD

<b>E</b>	PRODUCT SPEC. NANO SIM CARD	
TITLE:	H1.4 6P NANO SIM CARD 掀盖式	
PART NO.	CS-0029-06140W	
FILE NAME:		
SCALE	UNIT:mm	A4  SHEET: of

工程变更通知单号 ECN(DCN) NO.	版次 REV	日期 DATE	说明 DESCRIPTION	改变 CHANGE	承认 APPRO.	GENERAL TOLERANCE UNLESS OTHERWISE NOTED
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